TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7MZ273FK

Low-Voltage Octal D-Type Flip-Flop with Clear with 5-V Tolerant Inputs and Outputs

The TC7MZ273FK is a high-performance CMOS octal D-type flip-flop. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining CMOS low power dissipation.

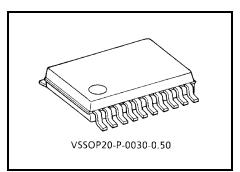
The device is designed for low-voltage (3.3-V) applications, but can also be used to interface both inputs and outputs with a 5-V supply environment.

D-input signal is sent to Q-output when clock rises. Clear input is Low-active and all flip-flop outputs are reset Low.

All inputs are equipped with protection circuits to guard against static discharge.

#### Features

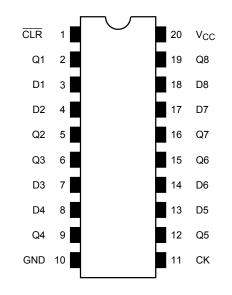
- Low voltage operation:  $V_{CC} = 2.0 V \sim 3.6 V$
- High-speed operation:  $t_{pd} = 8.5 \text{ ns} (max) (V_{CC} = 3.0 \text{ V} \sim 3.6 \text{ V})$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA} (min) (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: -500 mA
- Package: VSSOP (US20)
- Power-down protection is provided for all inputs and outputs.
- Pin and function compatible with the 74 Series (74AC/VHC/HC/F/ALS/LS etc.) 273 type.



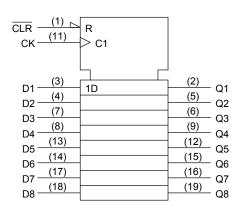
Weight: 0.03 g (typ.)

# TOSHIBA

### Pin Assignment (top view)



## **IEC Logic Symbol**

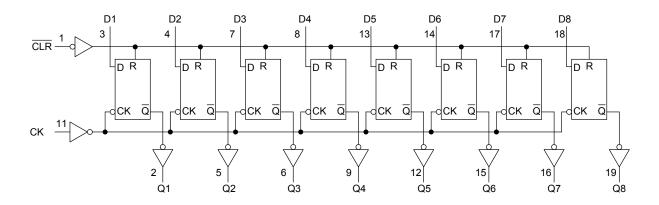


#### Truth Table

	Inputs		Outputs	Function
	D	СК	Q	T unction
L	Х	Х	L	Clear
н	L		L	—
н	Н		Н	—
Н	Х	$\overline{}$	Qn	No change

X: Don't care

# System Diagram



#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit	
Supply voltage range	V <sub>CC</sub>	-0.5~7.0	V	
DC input voltage	V <sub>IN</sub>	-0.5~7.0	V	
DC output voltage	Vout	-0.5~7.0 (Note 2)	V	
De ouput voltage	VOUT	-0.5~V <sub>CC</sub> + 0.5 (Note 3)	v	
Input diode current	I <sub>IK</sub>	-50	mA	
Output diode current	IOK	±50 (Note 4)	mA	
DC output current	IOUT	±50	mA	
Power dissipation	PD	180	mW	
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA	
Storage temperature	T <sub>stg</sub>	-65~150	°C	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 2: Output in off-state
- Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND, V_{OUT} > V_{CC}$ 

#### **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0~3.6	V	
Supply vollage	VCC	-1.5~3.6 (Note 2)	v	
Input voltage	V <sub>IN</sub>	0~5.5	V	
Output voltage	V <sub>OUT</sub>	0~5.5 (Note 3)	V	
Output voltage	V001	0~V <sub>CC</sub> (Note 4)	v	
Output current	IOH/IOI	±24 (Note 5)	mA	
output current	'OH''OL	±12 (Note 6)	IIIA	
Operating temperature	T <sub>opr</sub>	-40~85	°C	
Input rise and fall time	dt/dv	0~10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in off state

Note 4: High or low state

- Note 5:  $V_{CC} = 3.0 \sim 3.6 \text{ V}$
- Note 6:  $V_{CC} = 2.7 \sim 3.0 \text{ V}$

Note 7:  $V_{IN} = 0.8 \sim 2.0 \text{ V}, V_{CC} = 3.0 \text{ V}$ 

#### **Electrical Characteristics**

### DC Characteristics (Ta = -40~85°C)

Characteristics		Symbol	Test Condition			Min	Max	Unit
		Symbol			$V_{CC}(V)$			
High level		V <sub>IH</sub>		—		2.0	_	V
Input voltage	Low level	V <sub>IL</sub>	—		2.7~3.6	_	0.8	v
			I <sub>OH</sub> = -100 μA	2.7~3.6	V <sub>CC</sub> - 0.2	_		
	High level	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -12 mA	2.7	2.2	_	- - - V
				I <sub>OH</sub> = -18 mA	3.0	2.4	_	
Output voltage				I <sub>OH</sub> = -24 mA	3.0	2.2	_	
		N N		I <sub>OL</sub> = 100 μA	2.7~3.6	_	0.2	
				I <sub>OL</sub> = 12 mA	2.7	_	0.4	
	V <sub>OL</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 16 mA	3.0	_	0.4		
			I <sub>OL</sub> = 24 mA	3.0	_	0.55		
Input leakage cu	rrent	l <sub>IN</sub>	V <sub>IN</sub> = 0~5.5 V		2.7~3.6	_	±5.0	μA
Power off leakag	e current	I <sub>OFF</sub>	$V_{IN}/V_{OUT} = 5.5 V$		0	_	10.0	μΑ
Quiescent supply current	Icc	$V_{IN} = V_{CC} \text{ or GND}$ $V_{IN} = 3.6 \sim 5.5 \text{ V}$		2.7~3.6	_	10.0	μA	
				2.7~3.6	_	±10.0		
Increase in I <sub>CC</sub> per input		Δlcc	$V_{IN} = V_{CC} - 0.6 V$		2.7~3.6		500	

# AC Characteristics (Ta = -40~85°C)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
	fMAX		2.7			
Maximum clock frequency		Figure 1, Figure 2	$3.3\pm 0.3$	150		MHz
Propagation dology time (CK Q)	t <sub>PLH</sub>	Figure 1 Figure 2	2.7	_	9.5	
Propagation delay time (CK-Q)	t <sub>PHL</sub>	Figure 1, Figure 2	$\textbf{3.3}\pm\textbf{0.3}$	1.5	8.5	ns
Propagation delay time ( CLR -Q)	<b>t</b> =	Figure 1 Figure 2	2.7	_	9.5	ns
Propagation delay time (CLR -Q)	<sup>t</sup> PHL	Figure 1, Figure 3	$\textbf{3.3}\pm\textbf{0.3}$	1.5	8.5	
Minimum nulao width (CK)	t <sub>w (H)</sub>	Figure 1, Figure 2	2.7	3.3	_	
Minimum pulse width (CK)	t <sub>w (L)</sub>		$\textbf{3.3}\pm\textbf{0.3}$	3.3	_	ns
Minimum hug width $(\overline{OLP})$	<sup>t</sup> w (L)	Figure 3	2.7	3.3	_	
Minimum bus width ( CLR )			$\textbf{3.3}\pm\textbf{0.3}$	3.3	_	ns
Minimum set-up time			2.7	2.5	_	
Minimum sel-up lime	ts	Figure 1, Figure 2	$\textbf{3.3}\pm\textbf{0.3}$	2.5	_	ns
Minimum hold time	t <sub>h</sub>	Figure 1, Figure 2	2.7	1.5	_	
minimum noid ume			$\textbf{3.3}\pm\textbf{0.3}$	1.5	_	ns
Minimum removal time	+	Figure 4	2.7	2.5	—	
	t <sub>rem</sub>		$\textbf{3.3}\pm\textbf{0.3}$	2.0	_	ns
Output to output skew	t <sub>osLH</sub>	(Note)	2.7		—	
	t <sub>osHL</sub>		$3.3\pm 0.3$		1.0	ns

Note: This parameter is guaranteed by design.

 $(t_{\text{OSLH}} = |t_{\text{pLHm}} - t_{\text{pLHn}}|, t_{\text{OSHL}} = |t_{\text{pHLm}} - t_{\text{pHLn}}|)$ 

### **Dynamic Switching Characteristics**

#### (Ta = 25°C, Input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ Ω)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic VOL	VOLP	$V_{IH} = 3.3 V, V_{IL} = 0 V$	3.3	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

#### **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	CIN	_	3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_	0	8	pF
Power dissipation capacitance	CPD	f <sub>IN</sub> = 10 MHz (Note)	3.3	25	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:  $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$  (per bit)

# <u>TOSHIBA</u>

# AC Test Circuit

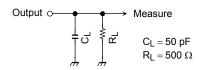


Figure 1

# AC Waveform

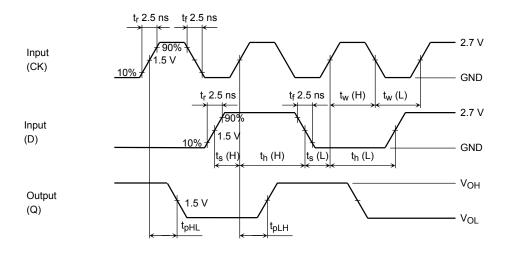


Figure 2  $t_{pLH}$ ,  $t_{pHL}$ ,  $t_w$ ,  $t_s$ ,  $t_h$ 

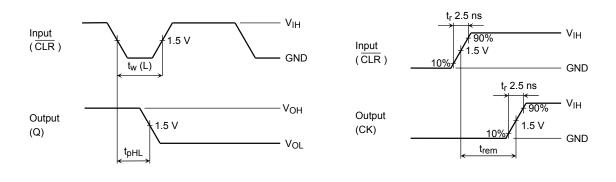
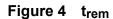


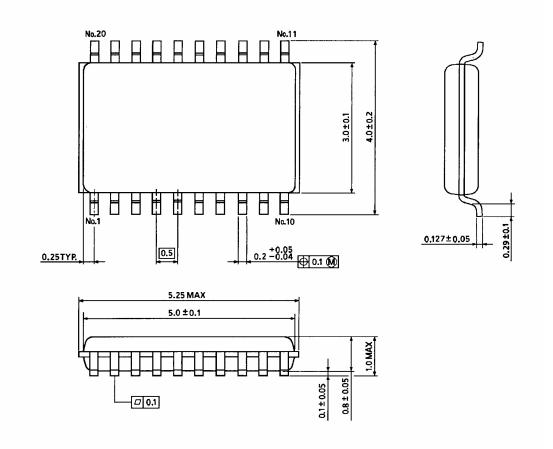
Figure 3 tpLH, tpHL



# **Package Dimensions**

VSSOP20-P-0030-0.50

Unit : mm



Weight: 0.03 g (typ.)

7

#### **RESTRICTIONS ON PRODUCT USE**

20070701-EN GENERAL

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third parties.
- Please contact your sales representative for product-by-product details in this document regarding RoHS compatibility. Please use these products in this document in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring as a result of noncompliance with applicable laws and regulations.